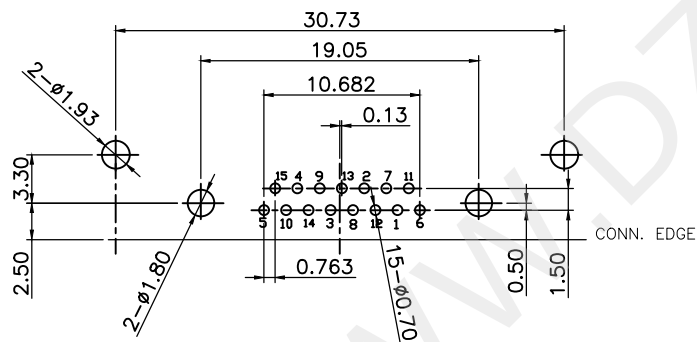
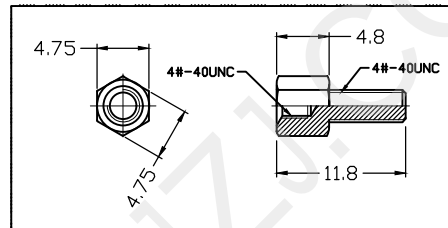
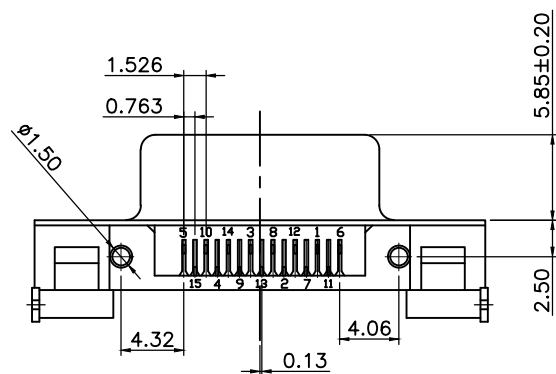
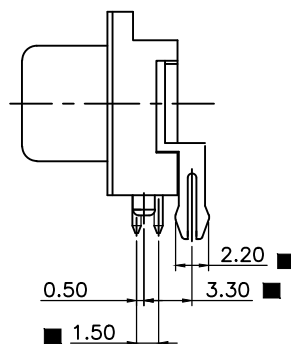
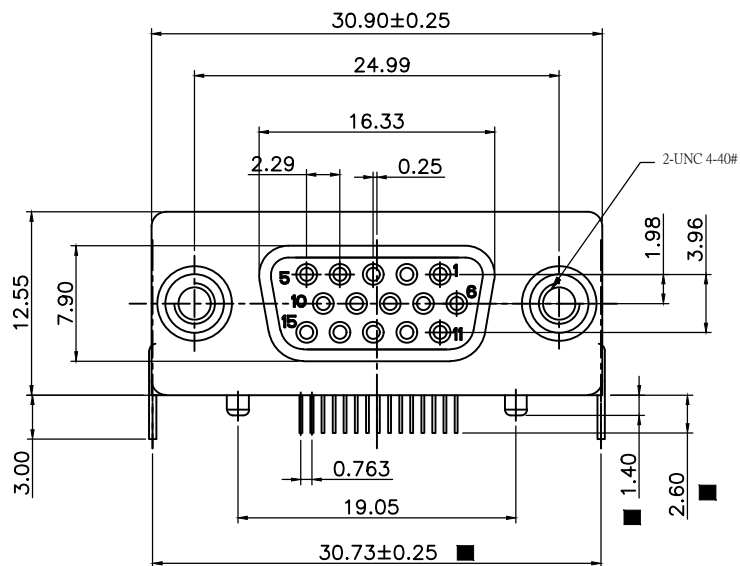




RECOMMENDED P.C.B LAYOUT(PCB THICKNESS: 1.6mm)
COMPONENT SIDE VIEW(TOLERANCE: ± 0.05)

1. MATERIAL&PLATING:
 - 1.1 INSULATOR: SEE ORDER INFORMATION, UL94V-0
INSULATOR COLOR: SEE ORDER INFORMATION.
 - 1.2 CONTACT: BRASS, GOLD FLASH PLATED IN CONTACT AREA,
80u"MIN TIN PLATED IN SOLDER AREA,
30u"MIN NICKEL UNDERPLATED OVERALL.
 - 1.3 SHELL: SPCC, NICKEL PLATED OVERALL.
 - 1.4 BOARD LOCK: SPCC, TIN PLATED OVER NICKEL UNDERPLATED OVERALL.
 - 1.5 REVJET: BRASS, 30u"MIN NICKEL PLATED OVERALL.
 - 1.6 SCREW: STEEL, NICKEL PLATED OVERALL.
2. SPECIFICATION:
 - 2.2 CURRENT RATING: 1.0A.
 - 2.3 CONTACT RESISTANCE: 25mΩ MAX.
 - 2.4 INSULATION RESISTANCE: 1000MΩ MIN.
 - 2.5 DIELECTRIC WITHSTANDING VOLTAGE: 500V PER MINUTE.
 - 2.6 OPERATING TEMPERATURE: -20°C~+85°C
3. NOTES:
 - 3.1 ALL COMPONENTS ARE RoHS COMPLIANT.
 - 3.2 RESISTANCE TO SOLDERING HEAT: 265°C FOR 5 SECONDS,
AND ONLY FOR WAVE SOLDERING PROCESS.



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY :	DATE :	PART NAME:	
X.X ±0.30		陈一鸣	2014-02-23	SLIM2.0 15P 母座侧鱼叉 前8后	
X.XX ±0.25					
X.XXX ±0.15					
X.* ±2* X.X* ±0.5*		CHECKED BY:	DATE :	PART NO.	HYC226-VGA15B-200
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]				APPROVED BY:	DATE :
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1